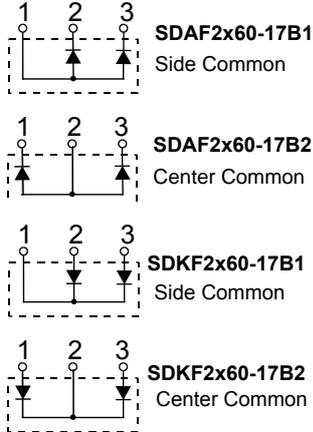
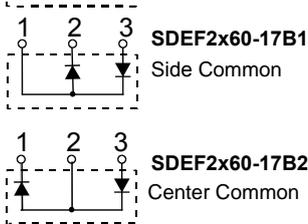
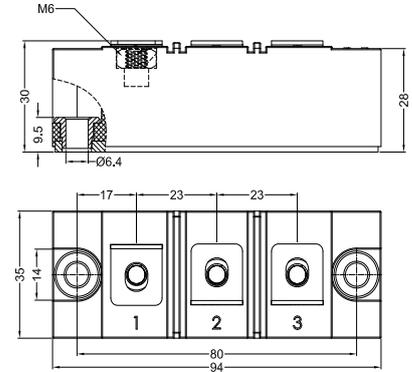


SDEF2x60-17B1

Soft Recovery Behaviour Ultra Fast Recovery Epitaxial Diode Modules



Dimensions in mm (1mm=0.0394")



	VRSM V	VRRM V
SDEF2x60-17B1	1700	1700
SDEF2x60-17B2	1700	1700

	VRSM V	VRRM V
SDAF2x60-17B1	1700	1700
SDAF2x60-17B2	1700	1700

	VRSM V	VRRM V
SDKF2x60-17B1	1700	1700
SDKF2x60-17B2	1700	1700

Symbol	Test Conditions	Maximum Ratings	Unit	
I _{FRMS}	T _C =85°C	90	A	
I _{FAM}	T _C =85°C; rectangular, d=0.5	2 x 60		
I _{FRM}	t _p <10us; rep. rating, pulse width limited by T _{VJM}	90		
I _{FSM}	T _{VJ} =45°C	t=10ms (50Hz), sine t=8.3ms (60Hz), sine	1000 1100	A
	T _{VJ} =150°C	t=10ms(50Hz), sine t=8.3ms(60Hz), sine	890 990	
I ² t	T _{VJ} =45°C	t=10ms (50Hz), sine t=8.3ms (60Hz), sine	5000 5500	A ² s
	T _{VJ} =150°C	t=10ms(50Hz), sine t=8.3ms(60Hz), sine	4400 4900	
T _{VJ} T _{stg} T _{Hmax}		-40...+150 -40...+125 110	°C	
P _{tot}	T _{case} =25°C	250	W	
V _{ISOL}	50/60Hz, RMS t=1min I _{ISOL} ≤1mA t=1s	4000 4500	V~	
M _d	Mounting torque (M6) Terminal connection torque (M6)	2.50-4/22-35 2.50-4/22-35	Nm/lb.in.	
d _s	Creeping distance on surface	12.7	mm	
d _A	Strike distance through air	9.6	mm	
a	Maximum allowable acceleration	50	m/s ²	
Weight		158	g	



SDEF2x60-17B1

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Symbol	Test Conditions	Characteristic Values		Unit
		typ.	max.	
I _R	T _{VJ} =25°C; V _R =V _{RRM}		0.4	mA
	T _{VJ} =25°C; V _R =0.8·V _{RRM}		0.4	
	T _{VJ} =125°C; V _R =0.8·V _{RRM}		20	
V _F	I _F =60A; T _{VJ} =125°C	2.05	2.45	V
	T _{VJ} =25°C	2.25	2.65	
	I _F =120A; T _{VJ} =125°C	2.35	2.75	
	T _{VJ} =25°C	2.55	2.99	
V _{TO}	For power-loss calculations only		1.50	V
r _T	T _{VJ} =125°C		8.85	mΩ
R _{thJH} R _{thJC}	DC current DC current		0.230 0.200	K/W
t _{rr}	I _F =1A; T _{VJ} =25°C -di/dt=200A/us	155	210	ns
	I _F =60A T _{VJ} =125°C -di/dt=200A/us	750	860	
Q _{rr}	T _{VJ} =125°C, I _F =60A, -di/dt=500A/μs, V _R =1200 V	16	20	μC
E _{rr}	T _{VJ} =125°C, I _F =60A, -di/dt=500A/μs, V _R =1200 V	5		mJ
I _{RM}	V _R =1200V; T _{VJ} =25°C		40	A
	-di/dt=500A/us; T _{VJ} =125°C		60	A

FEATURES

- * International standard package with Copper baseplate
- * Planar passivated chips
- * Short recovery time
- * Low switching losses
- * Soft recovery behaviour
- * Isolation voltage 3600 V~
- * RoHS compliant

APPLICATIONS

- * Antiparallel diode for high frequency switching devices
- * Free wheeling diode in converters and motor control circuits
- * Inductive heating and melting
- * Uninterruptible power supplies (UPS)
- * Ultrasonic cleaners and welders

ADVANTAGES

- * High reliability circuit operation
- * Low voltage peaks for reduced protection circuits
- * Low noise switching
- * Low losses

